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DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

	OLIGOMER COMPOSITION DISTRIBUTION AND PROCESSES FO			
the specificat	ion of which is attached hereto un	less the following is ch	ecked	
2004	on November 3, 2005 Iternational Application Number 5		cation Number 10/555,384 or	
I hereby state claim(s), as a	that I have reviewed and understanded by any amendment referr	and the contents of the a ed above.	above-identified specification	, including the
I acknowledg Regulations,	e the duty to disclose information § 1.56.	which is material to pa	tentability as defined in Title	37, Code of Federal
for patent or i	n foreign priority benefits under T inventor's certificate listed below tificate having a filing date before	and have also identified	l below any foreign application	on for patent or
(List prior foreig		that of the application	for which priority is claimed.	Priority Claimed
applications. See	JP2003-128644	Japan	7/May/2003	Yes □ No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	M Ics No
	JP2003-128646	Japan	7/May/2003	Yes □ No
	(Number)	(Country)	(Day/Month/Year Filed)	E3 100 E310
	JP2003-128660	Japan	7/May/2003	· · · 🛭 Yes 🔲 No
	(Number)	(Country)	(Day/Month/Year Filed)	
	JP2003-168693	Japan	13/June/2003	Yes □ No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B)	See attached list for	additional prior foreign	applications	
insofar as the in the manner information w	the benefit under Title 35, Unite subject matter of each of the claim provided by the first paragraph which is material to patentability aween the filing date of the price	ns of this application is of Title 35, United State as defined in Title 37, (not disclosed in the prior Un es Code, § 112, I acknowledge Code of Federal Regulations,	ited States application ge the duty to disclose § 1.56 which became
			Stat	rus
(List prior U.S. Applications)	(Application Serial No.)	(Filing Date)	Patented Pend	ding Abandoned
	(Application Serial No.)	(Filing Date)	Patented Pend	ding Abandoned
	(Application Schal No.)	(Lums Date)		1° . 🗆 Al - 1
	(Application Serial No.)	(Filing Date)	Palented _ Pend	ling

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850

Please direct all communications to the following address: .

23850 PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, ' 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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